

STGW33IH120D

30 A - 1200 V - very fast IGBT

Features

- Low saturation voltage
- High current capability
- Low switching loss
- Very soft ultra fast recovery antiparallel diode

Applications

- Induction cooking, microwave oven
- Soft switching application

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior. This device is well suited for the resonant or soft switching application.

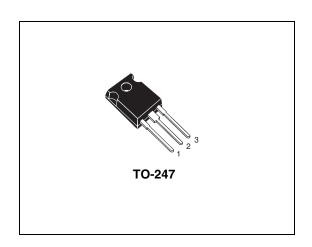


Figure 1. Internal schematic diagram

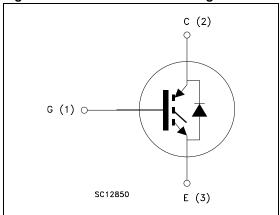


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW33IH120D	GW33IH120D	TO-247	Tube

Contents STGW33IH120D

Contents

1	Electrical ratings 3
2	Electrical characteristics
	2.1 Electrical characteristics (curves)
3	Test circuit
4	Package mechanical data11
5	Revision history

STGW33IH120D Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	1200	٧
I _C ⁽¹⁾	Collector current (continuous) at 25 °C	60	Α
I _C ⁽¹⁾	Collector current (continuous) at 100 °C	30	Α
I _{CL} ⁽²⁾	Turn-off latching current	45	Α
I _{CP} ⁽³⁾	Pulsed collector current	45	Α
V _{GE}	Gate-emitter voltage	±25	V
P _{TOT}	Total dissipation at T _C = 25 °C	220	W
I _F	Diode RMS forward current at T _C = 25 °C	30	Α
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal	100	А
T _j	Operating junction temperature	-55 to 150	°C

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C} \times V_{CESAT(MAX)}^{(T_{C}, I_{C})}}$$

- 2. Vclamp = 80% of V_{CES}, T_j =150 °C, R_G=10 Ω , V_{GE}=15 V
- 3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case IGBT max.	0.57	°C/W
R _{thj-case}	Thermal resistance junction-case diode max.	1.6	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max.	50	°C/W

Electrical characteristics STGW33IH120D

2 Electrical characteristics

(T_{CASE}= 25 °C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	1200			٧
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 20 A V _{GE} = 15 V, I _C = 20 A, Tc =125 °C		2.2 2.0	2.8	V V
V _{GE(th)}	Gate threshold voltage	V _{CE} = V _{GE} , I _C = 1 mA	3.75		5.75	٧
I _{CES}	Collector-cut-off current (V _{GE} = 0)	V _{CE} =1200 V V _{CE} =1200 V, Tc=125 °C			500 10	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} =± 20 V			± 100	nA
9 _{fs} (1)	Forward transconductance	V _{CE} = 25 V _, I _C = 20 A		20		S

^{1.} Pulsed: pulse duration= $300 \mu s$, duty cycle 1.5%

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} =0		2900 162 30		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V _{CE} = 960 V, I _C = 20 A,V _{GE} =15 V		127 18 50		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 960 \text{ V, } I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega \text{ V}_{GE} = 15 \text{ V,}$ (see Figure 17)		46 10 1660		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega \text{ V}_{GE} = 15 \text{ V},$ $T_{C} = 125 \text{ °C}$ (see Figure 17)		45 12 1500		ns ns A/µs
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω V _{GE} = 15 V, (see Figure 17)		102 284 180		ns ns ns
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega \text{ V}_{GE} = 15 \text{ V},$ $T_{C} = 125 \text{ °C}$ (see Figure 17)		200 424 316		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon ⁽¹⁾ $E_{off}^{(2)}$ E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 960 V, I_{C} = 20 A R_{G} = 10 Ω V _{GE} = 15 V, (see Figure 17)		1.5 3.4 4.9		mJ mJ mJ
Eon ⁽¹⁾ $E_{off}^{(2)}$ E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 960 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega \text{ V}_{GE} = 15 \text{ V},$ $T_{C} = 125 \text{ °C}$ (see Figure 17)		2.3 6.4 8.7		mJ mJ mJ

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGW33IH120D

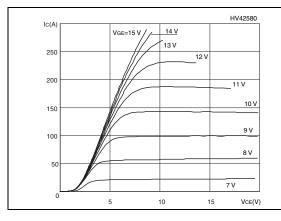
Table 8. Collector-emitter diode

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 20 A I _F = 20 A, T _C = 125 °C		1.9 1.7		V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time $I_F = 20 \text{ A}, V_R = 45 \text{ V},$ Reverse recovery charge $di/dt = 100 \text{ A/}\mu\text{s}$ Reverse recovery current $di/dt = 100 \text{ A/}\mu\text{s}$ (see Figure 20)			85 235 5.6		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_F = 20 A, V_R = 45 V, Tc = 125 °C, di/dt = 100 A/ μ s (see Figure 20)		152 722 9		ns nC A

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



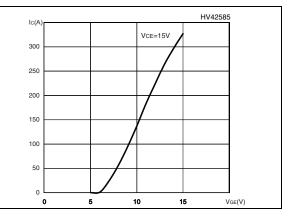
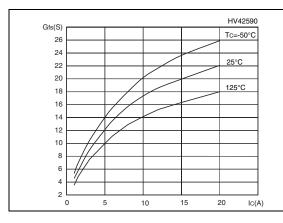


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



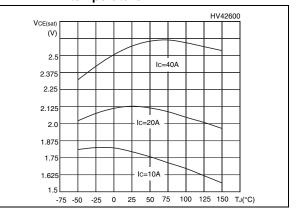
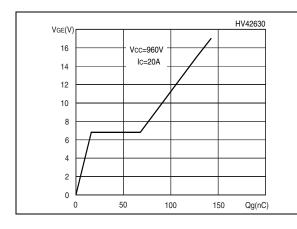
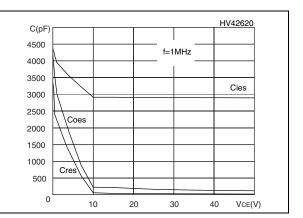


Figure 6. Gate charge vs gate-source voltage Figure 7. Capacitance variations

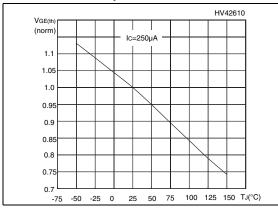




Electrical characteristics STGW33IH120D

Figure 8. Normalized gate threshold voltage vs temperature

Figure 9. Collector-emitter on voltage vs collector current



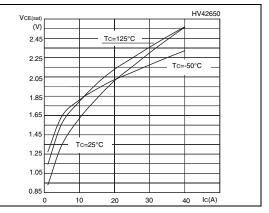
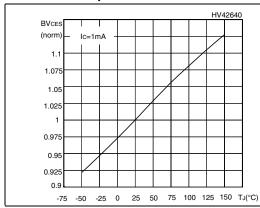


Figure 10. Normalized breakdown voltage vs temperature

Figure 11. Switching losses vs temperature



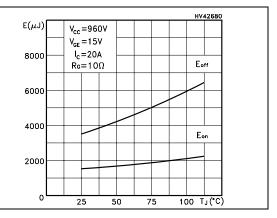
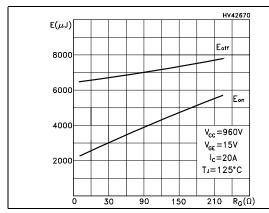
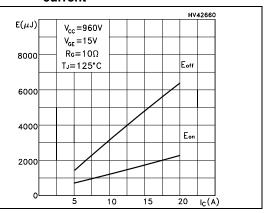


Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current





STGW33IH120D Electrical characteristics

Figure 14. Thermal impedance

Figure 15. Turn-off SOA

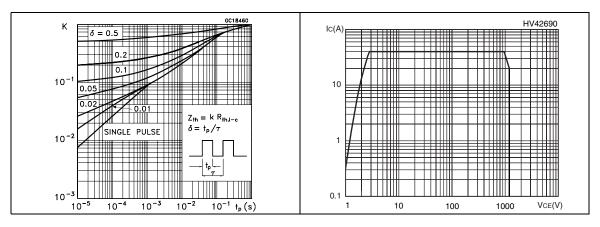
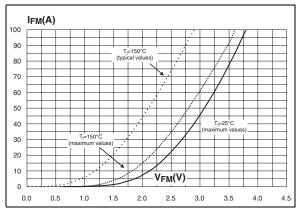


Figure 16. Emitter-collector diode characteristics



577

Test circuit STGW33IH120D

3 Test circuit

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

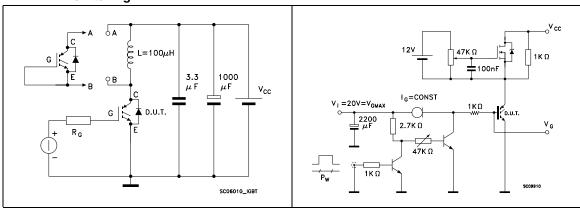
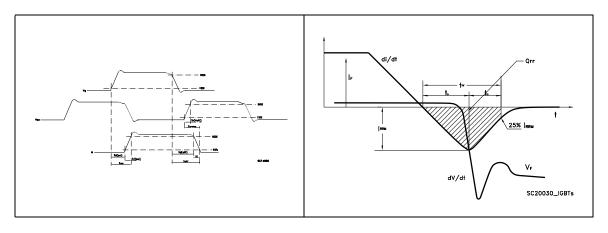


Figure 19. Switching waveform

Figure 20. Diode recovery time waveform



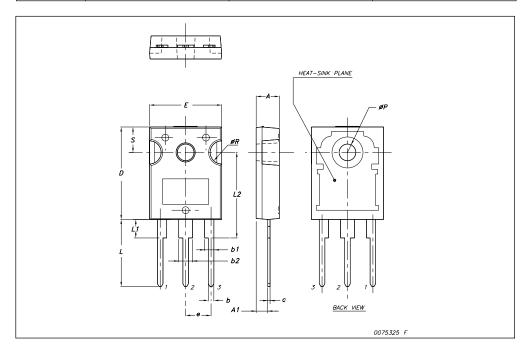
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

577

TO-247	Mech	anical	data
10-271	141001	ıaıııcaı	uata

Dim.		mm.	
Diiii.	Min.	Тур	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øΡ	3.55		3.65
øR	4.50		5.50
S		5.50	



577

STGW33IH120D Revision history

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
12-Mar-2008	1	Initial release

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477